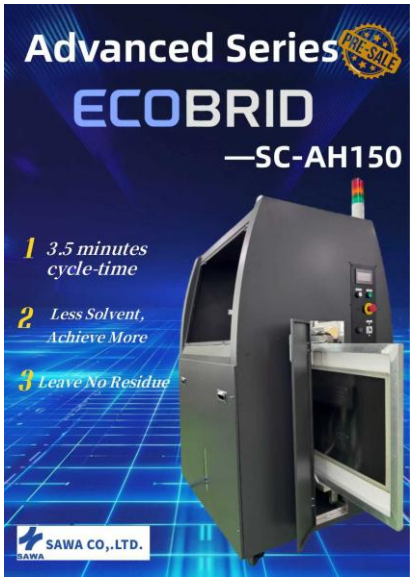
21241 S. Western Ave., #140
Torrance, CA 90501
Ph: 310-540-7310
Fax: 310-540-7930
Web site: www.seikausa.com

For Immediate Release

Contact
Seika Machinery, Inc.
310-540-7310
E-mail: info@seikausa.com
Web site: www.seikausa.com

Seika Machinery's SAWA EXOBRID AH150 Stencil Cleaner Wins 2026 Mexico Technology Award

TORRANCE, CA — October 2026 — Seika Machinery, Inc., a leading provider of advanced machinery, materials and engineering services, is proud to announce that its SAWA ECOBRID AH150 Stencil Cleaner System T100 received a 2026 Mexico Technology Award in the Screen/Stencil Printing Peripherals/Consumables category. The award was presented during a ceremony held before SMTA Guadalajara 2026 on Wednesday, October 7, 2026, in Guadalajara, Jalisco, Mexico.



The SAWA ECOBRID AH150 is a compact, fully automatic stencil cleaning system engineered to deliver fast, effective removal of solder paste residues while helping manufacturers improve print quality and process consistency. Designed for modern PCB assembly environments, the system combines low-VOC solvent technology with ultrasonic cleaning performance to provide thorough stencil maintenance with a takt time of less than 5 minutes.

Maintaining clean stencils is critical for achieving repeatable solder paste printing and reducing defects in high-volume electronics manufacturing. The SAWA ECOBRID AH150 helps manufacturers optimize this essential process step by providing automated cleaning performance in a space-efficient design that can be easily integrated into production environments.

In addition to improving cleaning efficiency, the system supports more sustainable manufacturing practices through reduced solvent usage and environmentally conscious operation. By extending stencil life and helping prevent print-related quality issues, the SAWA ECOBRID AH150 enables manufacturers to improve productivity while reducing waste and operational costs.

"We developed the SAWA ECOBRID AH150 to address the increasing need for efficient, reliable, and environmentally responsible stencil cleaning solutions," said Michelle Ogihara, Executive Vice President. "By combining automation, ultrasonic cleaning technology, and a compact production-friendly design, the system helps manufacturers maintain consistent printing performance while improving overall process efficiency."

The recognition from the Mexico Technology Awards highlights Seika Machinery's continued commitment to providing innovative solutions that help electronics manufacturers improve quality, productivity, and sustainability across the PCB assembly process.

The Mexico Technology Awards recognize the most recent technological innovations in Mexico's manufacturing landscape, spotlighting achievements by OEM manufacturing equipment and materials

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Web site: www.seikausa.com

suppliers over the past year. For more information about the awards, please visit www.mexicoems.com/mta-awards.

For more information, contact Michelle Ogihara at 310-540-7310; e-mail michelle@seikausa.com; or visit www.seikausa.com.

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About Seika Machinery, Inc.
Seika Machinery, Inc. (SMI) is a subsidiary of Seika Corporation, Japan and member of the Mitsubishi Global Group. SMI provides electronics manufacturers with advanced machinery, superior materials and engineering services.